

## CALENDAR

**Upcoming: December 3–6, 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications, MRS Endorsed.**

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

▼ identifies a new or revised entry this month.

See the September 2000 MRS BULLETIN for November 2000 Calendar entries.

### DECEMBER 2000

**3–5** 18th Annual Membrane Technology/Separations Planning Conf., *Newton, MA*. Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscomm.com.

**3–6** 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications, *London, UK*. E. Sühr, Lucent Technologies, 600 Mountain Ave., Rm. 1D-443, Murray Hill, NJ 07974; 908-582-5301; fax 908-582-5106; e-mail suhir@lucent.com. **Endorsed.**

**3–8** ▼ Conf. on Computational Physics, *Gold Coast, Queensland, Australia*. P. Drummond, Dept. of Physics, Univ. of Queensland, Brisbane QLD 4072, Australia; 61-7-3365-3405; fax 61-7-3365-1242; e-mail CP2000@physics.uq.edu.au; http://CCP2000.physics.uq.edu.au/.

**4–6** ▼ Conf. on Lithography Strategies: The Business and Technical Outlook for Next Generation Lithography, *San Diego, CA*. Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

**4–8** Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Las Vegas, NV*. T. Chandra, Univ. of Wollongong, Dept. of Materials Engineering, Northfields Ave., Wollongong NSW 2522, Australia; 61-42-21-3008; fax 61-42-21-3112; e-mail t.chandra@uow.edu.au.

**6–8** ACS Southeast/Southwest Regional Meeting, *New Orleans, LA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**10–15** Conf. on Molecular Electronics, *Kailua-Kona, HI*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

**18–20** Intl. Conf. on Fiber Optics and Photonics, *Calcutta, India*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

### JANUARY 2001

**6–11** AAPT and AAS Joint Winter Meeting, *San Diego, CA*. AAPT Meetings Dept., One Physics Ellipse, College Park, MD 20740; e-mail aapt-meet@aapt.org; www.aapt.org.

**7–10** Workshop on Nanostructured Materials Made from Self-Assembled Molecules and Particles, *Hindas, Sweden*. A. Palmqvist, Chalmers University of Technology, SE-412 96 Goeteborg, Sweden; fax 46-31-7722967; e-mail anders.palmqvist@surfchem.chalmers.se; www.kck.chalmers.se.

**8–9** Joint Magnetism and Magnetic Materials Conf. and the Intl. Magnetism Conf., *San Antonio, TX*. 202-973-8668; fax 202-973-8722; e-mail magnetism@courtesyassoc.com.

**8–10** PLASTEC™ West Plastics Conf., co-located with Medical Design & Manufacturing and Pacific Design & Manufacturing Conf., *Anaheim, CA*. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**9–11** Conf. on Optics in Computing, *Lake Tahoe, NV*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg\_conf/.

**10–12** Ultrafast Electronics and Optoelectronics Conf., *Lake Tahoe, NV*. Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**20–26** Photonics West Conf., *San Jose, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**21–26** 25th Intl. Conf. on Advanced Ceramics and Composites, *Cocoa Beach, FL*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**28–31** Conf. on Advanced Solid State Lasers, *Seattle, WA*. Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**28–31** Microtech Conf., *West London, UK*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

### FEBRUARY 2001

**5–7** IEEE Intl. Solid-State Circuits Conf., *San Francisco, CA*. D. Suiters, 202-331-2000; e-mail isscc@courtesyassoc.com.

**5–8** Conf. on Fourier Transform Spectroscopy and Optical Remote Sensing of the Atmosphere, *Coeur d'Alene, ID*. Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**5–9** ▼ 2nd Intl. Conf. on Microelectronics and Interfaces, *Santa Clara, CA*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; http://web.vacuum.org/icmi/default.asp.

**5–9** Advanced Research Workshop on Semiconductor Nanostructures, *Blenheim, New Zealand*. D.J. Lockwood, Inst. for Microstructural Sciences, Natl. Research Council of Canada, 1191 Montreal Rd., Bldg. M-36, Ottawa, Ontario, Canada K1A 0R6; 613-993-9614; fax 613-993-6486; e-mail david.lockwood@nrc.ca.

**9–11** ▼ 19th Southern Biomedical Engineering Conf., *Birmingham, AL*. Society For Biomaterials, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 763-543-0908; fax 763-545-0335; www.biomaterials.org.

**9–12** ▼ Conf. on Vision Science and Its Applications, and 2nd Intl. Congress on Wavefront Sensing and Aberration-Free Refractive Correction, *Monterey, CA*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg\_conf/.

**11–15** TMS Annual Meeting, *New Orleans, LA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; http://www.tms.org/cms.

**19–22** 4th Industrial Energy Efficiency Symposium, *Washington, DC*. Office of Industrial Technologies, EE-20, U.S. Dept. of Energy, 1000 Independence Ave., S.W., Washington, DC 20585; www.oitexpo4.com.

**21–23** Intl. Conf. on Trends in Mechanical Alloying, *Jaipur, India*. P.R. Soni, Dept. of Met. Engrg., M.R. Eng. College, Jaipur 302017, India; 91-0141-702042; fax 91-0141-702954; e-mail psmt@arya.recjai.ernet.in.

**25–2** Microlithography Conf., *Santa Clara, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**26–28** ▼ Compound Semiconductor Outlook Conf., *San Diego, CA*. Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

### MARCH 2001

**4–8** SPIE 8th Annual Intl. Symposium on Smart Structures and Materials, *Newport Beach, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5–8** Intl. Laser Safety Conf., *San Diego, CA*. Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.laserinstitute.org.

**5–9** 7th Intl. Conf. on the Science of Hard Materials, *Ixtapa, Mexico*. C. Grigorescu, Dept. of Mat. Tech., INTEVEP-PDVSA, Los Teques, Venezuela, 58-2-908-6843; fax 58-2-908-6916; e-mail grigorescuc@pdvsa.com; www.upc.es/cmcm/ICSHM7.

**11–14** ▼ Intl. Symposium on Advanced Packaging Materials, *Braselton, GA*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**11–15** 10th Biennial Workshop on Organometallic Vapor Phase Epitaxy, *San Diego, CA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**11–16** NACE 56th Annual Conf., *Washington, DC*. NACE, P.O. Box 218340, Houston, TX 77218; 281-228-6223; fax 281-228-6329; e-mail msd@mail.nace.org; www.nace.org.

**12–16** APS March Meeting, *Seattle, WA*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**17–22** Optical Fiber Communication Conf., *Anaheim, CA*. Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail cust.serv@osa.org; www.osa.org.

**19-21** Intl. Conf. on Computational Nanoscience and 4th Intl. Conf. on Modeling and Simulation of Microsystems, *Hilton Head, SC*. ICCN 2001, 4847 Hopyard Rd., Ste. 4-381, Pleasanton, CA 94588; 925-847-9152; fax 925-847-9153; e-mail [wenning@dnai.com](mailto:wenning@dnai.com); [www.cr.org](http://www.cr.org).

**25-28** ▼ Conf. on Nonlinear Guided Waves and Their Applications, *Clearwater, FL*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail [custserv@osa.org](mailto:custserv@osa.org); [www.osa.org/mtg\\_conf/](http://www.osa.org/mtg_conf/).

**25-29** ▼ Microscopy of Semiconducting Materials XII, *Oxford, UK*. E-mail [jenny@rms.org.uk](mailto:jenny@rms.org.uk); [www.rms.org.uk](http://www.rms.org.uk).

**25-30** 199th Meeting of the Electrochemical Society, *Washington, DC*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); <http://www.electrochem.org/meetings/>. **Symposium Endorsed.**

**26-27** ▼ Conf. on Ceramic Technologies for Microwave, *Denver, CO*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail [imaps@imaps.org](mailto:imaps@imaps.org); [www.imaps.org](http://www.imaps.org).

## APRIL 2001

**2-4** Intl. Sherwood Fusion Theory Conf., *Santa Fe, NM*. C. Sovinec, Los Alamos Natl. Lab., T-15, MS K717, Los Alamos, NM 87545; 505-667-4394; fax 505-665-7150; e-mail [sovinec@lanl.gov](mailto:sovinec@lanl.gov); <http://t15web.lanl.gov/sherwood2001/>.

**16-20** MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org). **MRS.**

**18-20** ▼ Intl. Conf. on Electronics Packaging, and 15th Microelectronics Show, *Tokyo, Japan*. Secretariat, 2001 ICEP, JIEP, 3-12-2 Nishiogikita, Suginamu-ku, Tokyo 167-0042, Japan; 81-3-5310-2010; fax 81-3-5310-2011; e-mail [imaps-j@jiep.or.jp](mailto:imaps-j@jiep.or.jp); [www.jiep.or.jp/index.html](http://www.jiep.or.jp/index.html).

**21-26** 44th SVC Conf., *Philadelphia, PA*. Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; 505-856-6716; e-mail [svcinfo@svc.org](mailto:svcinfo@svc.org).

**22-25** ACerS 103rd Annual Meeting, *Indianapolis, IN*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail [customersrv@acers.org](mailto:customersrv@acers.org); [www.ceramics.org](http://www.ceramics.org).

**22-25** Conf. on Materials and Science in Sports, *Coronado, CA*. F.H. Froes, Univ. of Idaho, Inst. of Materials and Advanced Proc., Mines Bldg., Rm. 321, Moscow, ID 83844-3026; 208-885-7989; fax 208-885-4009; e-mail [imap@uidaho.edu](mailto:imap@uidaho.edu).

**22-26** AIChE Spring National Meeting, *Houston, TX*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail [meetmail@aiche.org](mailto:meetmail@aiche.org); [www.aiche.org/conferences/](http://www.aiche.org/conferences/).

**23-27** 13th Intl. Conf. on Wear of Materials, *Vancouver, Canada*. A. Hill, Conf. Secretariat; Elsevier Science, the Boulevard, Langford Lane, Kidlington, Oxford, Oxon OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail [a.richardson@elsevier.co.uk](mailto:a.richardson@elsevier.co.uk); [www.elsevier.com/locate/wom](http://www.elsevier.com/locate/wom).

**23-27** APS April Meeting, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**24-29** ▼ 27th Annual Meeting of the Society For Biomaterials, *St. Paul, MN*. Society For Biomaterials, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 763-543-0908; fax 763-545-0335; [www.biomaterials.org](http://www.biomaterials.org).

**28-1** ▼ APS April Meeting, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail [meetings@aps.org](mailto:meetings@aps.org); [www.aps.org](http://www.aps.org).

## MAY 2001

**6-11** Conf. on Lasers and Electro-Optics, and Quantum Electronics and Laser Science Conf., *Baltimore, MD*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail [confserv@osa.org](mailto:confserv@osa.org); [www.osa.org/mtg\\_conf](http://www.osa.org/mtg_conf).

**9-11** 14th Radio Frequency Topical Conf., *Oxnard, CA*. T.K. Mau, Univ. of California at San Diego, Fusion Energy Research Program, Rm. 460, EBU-II, 9500 Gilman Dr., La Jolla, CA 92093-0417; 858-534-2880; fax 858-534-7716; e-mail [mau@aries.ucsd.edu](mailto:mau@aries.ucsd.edu); [www.ferp.ucsd.edu/~mau/RF2001](http://www.ferp.ucsd.edu/~mau/RF2001).

**12-17** ▼ 16th Intl. Conf. on Cyclotrons and Their Applications, *East Lansing, MI*. F. Marti, Natl. Superconducting Cyclotron Lab., Michigan State Univ., East Lansing, MI 48824-1321; fax 517-353-5967; e-mail [marti@ncsl.msu.edu](mailto:marti@ncsl.msu.edu).

**14-15** ▼ Conf. on Materials Science and Engineering: Its Nucleation and Growth, *London, UK*. M. McLean, Dept. of Materials, Imperial College of Science, Technology, and Medicine, Prince Consort Rd., London SW7 2BP, UK; fax 44-20-7594-6736; e-mail [m.mclean@ic.ac.uk](mailto:m.mclean@ic.ac.uk).

**16-25** Sikkim Intl. Nanotribology Symposium, *Sikkim, India*. S.K. Biswas, Dept. Mechanical Engineering, Indian Institute of Science, Bangalore 560012, India; 91-80-3600586/3092963; fax 91-80-3600648; [nanosikkim@mecheng.iisc.ernet.in](mailto:nanosikkim@mecheng.iisc.ernet.in); [www.mecheng.iisc.ernet.in/nanosikkim.html](http://www.mecheng.iisc.ernet.in/nanosikkim.html).

**21-23** ▼ 3rd Intl. Symposium on Polymer Surface Modification, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/surfmod3.htm>.

**23-25** 4th Intl. Conf. on Marine Technology, *Szczecin, Poland*. K. Savage, Wessex Inst. of Technology, WIT Marketing Coordinator, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail [ksavage@wessex.ac.uk](mailto:ksavage@wessex.ac.uk).

**24-25** ▼ Intl. Symposium on Surface Contamination and Cleaning, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/surfclean.htm>.

**28-1** ▼ 15th Intl. PLANSEE Seminar: Powder Metallurgical High Performance Materials, *Reutte, Austria*. P. Rodhammer, Conf. Secretary, PLANSEE Holding AG, A-6600 Reutte, Austria; 43-5672-600-2800; fax 43-5672-600-62800; e-mail [plansee.seminar@plansee.at](mailto:plansee.seminar@plansee.at); [www.plansee.com](http://www.plansee.com).

## JUNE 2001

**5-7** PLASTEC™ East Plastics Conf., co-located with Medical Design & Manufacturing East and Atlantic Design & Manufacturing Conf., *New York, NY*. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; [www.canontradeshows.com](http://www.canontradeshows.com).

**6-8** Conf. on Optical Engineering for Sensing and Nanotechnology, *Yokohama, Japan*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**10-13** 75th Colloid and Surface Science Symposium, *Pittsburgh, PA*. S. Garoff, 412-268-6877; fax 412-681-0648; e-mail [sg2e@andrew.cmu.edu](mailto:sg2e@andrew.cmu.edu); <http://colloids2001.cheme.cmu.edu>.

**10-14** EUROMAT 2001 Conf., *Rome, Italy*. AIM, Piazzale Rodolfo Morandi 2-1-20121 Milano, Italy; 39-2-7639-7770; fax 39-2-7602-0551; e-mail [aim@fast.mi.it](mailto:aim@fast.mi.it); [www.fast.mi.it/aim/euromat.htm](http://www.fast.mi.it/aim/euromat.htm).

**13-15** ▼ 3rd Intl. Symposium on Acid-Base Interactions, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/acidbase3.htm>.

**17-20** 5th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, *Pittsburgh, PA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [tmsgeneral@tms.org](mailto:tmsgeneral@tms.org); [www.tms.org/cms](http://www.tms.org/cms).

**18-20** ▼ 3rd Intl. Symposium on Silanes and Other Coupling Agents, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/silane3.htm>.

**19-21** 6th Intl. Workshop on Plasma-Based Ion Implantation, *Grenoble, France*. Y. Pauleau, CNRS-LEMD, B.P. 166, 25 Rue des Martyrs, 38042 Grenoble Cedex 9, France; 33-4-7688-1071; fax 33-4-7688-7945; e-mail [pauleau@polycnrs-gre.fr](mailto:pauleau@polycnrs-gre.fr); [www.polycnrs-gre.fr](http://www.polycnrs-gre.fr).

**20-22** ▼ Conf. on Laser and Laser Information Technology, *Vladimir, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**23-30** 12th APS Topical Conf. on Shock Compression of Condensed Matter, *Atlanta, GA*. A. Roach, Los Alamos Natl. Lab.; 505-665-6277; e-mail [aita@lanl.gov](mailto:aita@lanl.gov).

**24-27** ▼ 2001 International Workshop on Superconductivity (ISTEC), *Honolulu, Hawaii*. Workshop Coordinators: Tetsuji Kobayashi, ISTECC and Elton N. Kaufmann, Argonne National Laboratory; fax +81-3-3431-4044; e-mail [t-kobayashi@istec.or.jp](mailto:t-kobayashi@istec.or.jp); [www.istec.or.jp/ISTEC\\_homepage/WORK/e-workshop.html](http://www.istec.or.jp/ISTEC_homepage/WORK/e-workshop.html). **MRS.**

**25-28** Natl. Space and Missile Materials Symposium, *Monterey, CA*. Space and Missile Symposium, c/o Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431; 937-254-7950; fax 937-253-2296; [www.usasymposium.com](http://www.usasymposium.com).

**26-1** 17th Intl. Conf. on Coherent and Nonlinear Optics, *Minsk, Belarus*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**27-29** Electronic Materials Conf., *Notre Dame, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [tmsgeneral@tms.org](mailto:tmsgeneral@tms.org); [www.tms.org/cms](http://www.tms.org/cms).

## JULY 2001

**1-6** ▼ Gordon Research Conf. on Materials Processes Far from Equilibrium, *Andover, NH*. Gordon Research Conferences, Univ. of Rhode Island, P.O. Box 984, West Kingston, RI 02892-0984; e-mail [app@grcmail.grc.uri.edu](mailto:app@grcmail.grc.uri.edu); [www.grc.uri.edu/regpay/reg.htm](http://www.grc.uri.edu/regpay/reg.htm).

**2-6** Conf. on Electric Charges in Nonconductive Materials, *Tours, France*. SFV Div. Dielectriques, 19 Rue du Renard, 75004 Paris, France; 33-153-019-030; fax 33-142-786-320; e-mail [sfv@vide.org](mailto:sfv@vide.org); [www.vide.org/GSC4.html](http://www.vide.org/GSC4.html).

**15-21** ▼ 21st IUPAP Intl. Conf. on Statistical Physics, *Cancun, Mexico*. A. Robledo, IFUNAM, Apartado Postal 20-364, Mexico 01000, D.F., Mexico; 525-622-5095; fax 525-622-5008; e-mail [staphys@varea.ifisicacu.unam.mx](mailto:staphys@varea.ifisicacu.unam.mx); <http://varea.ifisicacu.unam.mx/statphys21.htm>.

**16-20** 4th Intl. Conf. on Nitride Semiconductors (ICNS-4), *Denver, CO*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org). **MRS.**

**16-20** ▼ 21st Intl. Conf. on Defects in Semiconductors, *Giessen, Germany*. ICDS 21, D. Musaeus, I. Physikalisches Inst., Heinrich-Buff-Ring 16, D-35392 Giessen, Germany; e-mail [ICDS21@physik.uni-giessen.de](mailto:ICDS21@physik.uni-giessen.de); [www.uni-giessen.de/icds21](http://www.uni-giessen.de/icds21).

**16-20** Cryogenic Engineering Conference & International Cryogenic Materials Conference (CEC-ICMC), *Madison, WI*. Centennial Conferences, 4800 Baseline Road, A-112, Boulder, CO 80303 USA; 303-499-2299; fax 303-499-2599; e-mail [cec-icmc@centennialconferences.com](mailto:cec-icmc@centennialconferences.com); [www.cec-icmc.org](http://www.cec-icmc.org)

**18-24** 22nd Intl. Conf. on Photonic, Electronic, and Atomic Collisions, *Santa Fe, NM*. S. Datz, Oak Ridge Natl. Lab., P.O. Box 2008, Oak Ridge, TN; 865-574-4984; fax 865-574-1118; e-mail [icpeac@phy.ornl.gov](mailto:icpeac@phy.ornl.gov); <http://icpeac2001.phy.ornl.gov.html>

**23-27** 13th Intl. Conf. on Vacuum UV Radiation Physics, *Trieste, Italy*. e-mail [renato.gioppo@elettra.trieste.it](mailto:renato.gioppo@elettra.trieste.it); <http://vuv13.elettra.trieste.it/vuv13/>

**29-3** 19th Intl. Conf. on Atomic Collisions in Solids, *Paris, France*. V.A. Esaulov, Lab. des Collisions Atomiques et Moleculaires, Bat. 351, Univ. de Paris Sud, 91405 Orsay Cedex, France; 33-69-15-76-80; fax 33-69-15-76-71; e-mail [icacs19@veof1.lcam.u-psud.fr](mailto:icacs19@veof1.lcam.u-psud.fr); <http://veof1.lcam.u-psud.fr/idc/icacs19.html>

**29-3** SPIE Annual Meeting and Intl. Symposium on Optical Science and Technology, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org)

**30-3** 4th Intl. Conf. on Biological Physics, *Kyoto, Japan*. M. Go, Div. of Biological Science, Graduate School of Science, Nagoya Univ., Furo-cho, Chikusa-ku, Nagoya 464-8602, Japan; e-mail [icbp2001@kokusai.phys.nagoya-u.ac.jp](mailto:icbp2001@kokusai.phys.nagoya-u.ac.jp); <http://kokusai.phys.nagoya-u.ac.jp/>

**30-3** Nonneutral Plasma Physics Workshop, *La Jolla, CA*. C.F. Driscoll, Organizing Committee Chair, Univ. of California at San Diego, Physics Dept., 0319, 9500 Gilman Dr., La Jolla, CA 92093-0319; 858-534-2489; fax 858-534-0173; e-mail [fdriscoll@ucsd.edu](mailto:fdriscoll@ucsd.edu); <http://sdphCA.ucsd.edu/NNP/>

## AUGUST 2001

**12-17** 10th Intl. Conf. on Phonon Scattering in Condensed Matter, *Hanover, NH*. Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail [phonons@mac.dartmouth.edu](mailto:phonons@mac.dartmouth.edu); [www.dartmouth.edu/~phonon](http://www.dartmouth.edu/~phonon)

**13-17** 10th Canadian Semiconductor Technology Conf., *Ottawa, Ontario, Canada*. M. Lanouette, Conf. Mgr., Conf. Services Office, Natl. Research Council Canada, Bldg. M-19, Ottawa, Ontario, Canada K1A 0R6; 613-993-0414; fax 613-993-7250; e-mail [marie.lanouette@nrc.ca](mailto:marie.lanouette@nrc.ca)

**26-31** 13th European Conference on Chemical Vapor Deposition (EUROCV13), *Athens, Greece*. [www.imel.demokritos.gr/EUROCV13/Eurocvd13.html](http://www.imel.demokritos.gr/EUROCV13/Eurocvd13.html)

**27-31** Conf. on Recrystallization and Grain Growth, *Aachen, Germany*. D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail [ReX&GG@imm.rth-aachen.de](mailto:ReX&GG@imm.rth-aachen.de)

## SEPTEMBER 2001

**2-7** 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, *San Francisco, CA*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); [www.electrochem.org](http://www.electrochem.org)

**9-14** Conf. on Surface Modification of Materials by Ion Beams, *Marburg, Germany*. D. Rueck, Gesellschaft für Schwerionenforschung mbH, Planckstrasse 1, D-64291 Darmstadt, Germany; 49-6159-71-2603; fax 49-6159-71-2505; e-mail [D.Rueck@gsf.de](mailto:D.Rueck@gsf.de); [www.gsi.de](http://www.gsi.de)

**14-16** 4th Intl. Conf. on Peer Review in Biomedical Publication, *Barcelona, Spain*. A. Flanagan, JAMA, 515 N. State St., Chicago, IL 60610; 312-464-2432; fax 312-464-5824; e-mail [jama-peer@ama-assn.org](mailto:jama-peer@ama-assn.org)

**16-21** Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, *Moran, WY*. N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. **Endorsed.**

**17-21** Conf. on X-Ray and Neutron Capillary Optics, *Zvenigorod, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org)

**17-21** Intl. Symposium on Advanced Materials, *Islamabad, Pakistan*. A.A. Mazhar, Secretary Symposium, A.Q. Khan Res. Lab., Kahuta, P.O. Box 905, Rawalpindi, Pakistan, 92-51-928-0541; fax 92-51-928-0542; e-mail [compudiv@asb.paknet.com.pk](mailto:compudiv@asb.paknet.com.pk)

**18-21** Intl. Conf. on Advances in Materials and Processing Technologies, *Madrid, Spain*. AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CON-GREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail [congrega@fund.uc3m.es](mailto:congrega@fund.uc3m.es); e-mail [ampt01@ing.uc3m.es](mailto:ampt01@ing.uc3m.es)

**23-26** TMS Fall Extraction and Process Metallurgy Meeting, *San Diego, CA*. M. Cross, School of Computing and Mathematical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

**23-27** 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [tmsgeneral@tms.org](mailto:tmsgeneral@tms.org); [www.tms.org/meetings/](http://www.tms.org/meetings/)

**23-27** 6th World Congress of Chemical Engineering, *Melbourne, Australia*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail [meetmail@aiche.org](mailto:meetmail@aiche.org); [www.aiche.org/conferences/](http://www.aiche.org/conferences/)

**23-27** ACS Southeast Regional Meeting, *Savannah, GA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail [help@acs.org](mailto:help@acs.org); [www.acs.org](http://www.acs.org)

## OCTOBER 2001

**3-5** Conf. on Photomask Technology and Management, *Monterey, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org)

**10-13** ACS Midwest Regional Meeting, *Lincoln, NE*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail [help@acs.org](mailto:help@acs.org); [www.acs.org](http://www.acs.org)

**14-18** 6th Intl. Symposium on Self-Propagating High-Temperature Synthesis, *Haifa, Israel*. Dept. of Materials Engineering, TECHNION-Israel Inst. of Technology, Technion City, Haifa 32000, Israel; 972-4-829-2112; fax 972-4-832-1978; e-mail [gutmanas@tx.technion.ac.il](mailto:gutmanas@tx.technion.ac.il); [www.technion.ac.il/technion/materials](http://www.technion.ac.il/technion/materials)

**17-20** ACS Southwest Regional Meeting, *San Antonio, TX*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail [help@acs.org](mailto:help@acs.org); [www.acs.org](http://www.acs.org)

**17-20** Fall Meeting of the APS Division of Nuclear Physics, *Maui, HI*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org)

**28-31** ACS Western Regional Meeting, *Santa Barbara, CA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail [help@acs.org](mailto:help@acs.org); [www.acs.org](http://www.acs.org)

**29-2** Meeting of the APS Div. of Plasma Physics, *Long Beach, CA*. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail [meetings@aps.org](mailto:meetings@aps.org); [www.aps.org](http://www.aps.org)

## NOVEMBER 2001

**4-8** Intl. Conf. on Advanced Ceramics and Glasses, *Maui, HI*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail [info@acers.org](mailto:info@acers.org); [www.acers.org/meetings/](http://www.acers.org/meetings/)

**4-8** TMS Fall Meeting, *Indianapolis, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [weissp@tms.org](mailto:weissp@tms.org); [www.tms.org](http://www.tms.org)

**4-9** AIChE Annual Meeting, *Reno, NV*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail [meetmail@aiche.org](mailto:meetmail@aiche.org); [www.aiche.org/conferences/](http://www.aiche.org/conferences/)

**5-7** 2nd Intl. Symposium on Adhesion Aspects of Thin Films, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/adhtf2.htm>

**7-9** 3rd Intl. Symposium on Adhesion Measurement of Thin Films and Coatings, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/adhmeas3.htm>

**26-30** MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org). **MRS.**

## DECEMBER 2001

**3-5** 2nd Intl. Symposium on Polyimides and Other High Temperature Polymers, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/polyim2.htm>

**3-7** 10th Intl. Congress of Fracture, *Honolulu, HI*. A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail [a.richardson@elsevier.co.uk](mailto:a.richardson@elsevier.co.uk); [www.elsevier.com](http://www.elsevier.com)

**6-7** 8th Intl. Symposium on Metallized Plastics, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rh@mstconf.com](mailto:rh@mstconf.com); <http://mstconf.com/metalplas8.htm>

**11-15** 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail [ccpricm4@imr.tohoku.ac.jp](mailto:ccpricm4@imr.tohoku.ac.jp)

## JANUARY 2002

**6-11** 13th Intl. Conf. on Ternary and Multinary Compounds, *Dead Sea, Israel*. D. Cahen, Dept. of Materials and Interfaces, Weizmann Inst. of Science, Rehovoth, Israel 76100; 972-0-89-34-2246; fax 972-0-89-34-4139; e-mail [david\\_cahen@vz.zmanna.ac.il](mailto:david_cahen@vz.zmanna.ac.il); [www.weizmann.ac.il/aterial/](http://www.weizmann.ac.il/aterial/)

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